APPLICABLE			microSD Memory Card Specifications Ver 1.10								
STANDARD OPERATING			STORAG			_					
		ATURE RANGE	-25 °C TO +85 °C (NO	TE1)	I	ATURE RA	NGE	-40 °C TO +85 °C			
RATING VOLTAG		E	AC 125V			Y RANGE 95%MAXIMU					
								(NON-CONDENS	SING)		
			SPE	ECI	FICAT	IONS					
ITEN	М		TEST METHOD			REQUIREMENTS QT A				AT	
CONSTRUCTION			D DV MEACHDING INCTDUMENT			Table of Dr. Marine					
GENERAL EXAMINATION		VISUALLY AND BY MEASURING INSTRUMENT.				ACCORDING TO DRAWING.			×	×	
		CONFIRMED VISUALLY.							X	×	
ELECTRI	IC CHAI	L RACTERISTIC	ACTERISTICS								
CONTACT		OPEN VOLTAGE 20 mV AC MAX, INITIALLY 100 mΩ MAXIMUM (NOTE 2).							X	T -	
RESISTANCE MILLIVOLT LEVEL METHOD IEC60512-2-2a		TEST CURRENT 1mA.									
VOLTAGE		500 Vrms AC IS APPLIED FOR 1 MINUTE.				①NO FLASHOVER OR BREAKDOWN.				X	
PROOF IEC60512-2-4a						②CURRENT LEAKAGE 1mA MAXIMUM.					
		MEASURE WIT	SURE WITHIN 1 MINUTE AFTER APPLYING				INITIALLY 1000 MΩ MINIMUM.				
RESISTANCE IEC60512-2-3a		500 V DC.									
		L HARACTERIS	TICS								
		MEASURED BY APPLICABLE CORD AT 25mm/min.				THE INIT	IAL STAGE:10) N MAX.	X		
FORCE CARD UNROCK FORCE						AFTER MECHANICAL OPERATION:12N MAX.				_	
MECHANICAL OPERATION [OFFICE ENVIRONMENT] EIA364B class1.1		5,000 TIMES INSERTIONS AND WITH DRAWAL SHALL BE MADE AT THE CYCLE RATE LESS THAN 10 CYCLES PER 1 MINUTE.				 ① CONTACT RESISTANCE: AFTER TEST 40 mΩ MAXIMUM CHANGE. (CONTACT RESISTANCE REVERSION BY INSERTION AND EXTRACTION IS AVAILABLE) ② NO MECHANICAL DAMAGE SHALL OCCUR ON THE PARTS. 				-	
HIGH FREQUENCY		FREQUENCY 10 TO 55 TO 10 Hz/min, SINGLE AMPLITUDE 0.75 mm FOR 4 h IN 3 DIRECTIONS, TOTAL 12 h.				① NO ELECTRICAL DISCONTINUITY OF 100 ns.			×	_	
IEC60512-4-6d						② NO MECHANICAL DAMAGE SHALL OCCUR ON THE PARTS.			8		
SHOCK IEC60512-4-6c		ACCELERATION 490m/s ² STANDARD HOLDING TIME 11 ms, SEMI-SINE WAVE FOR 3TIMES IN 3 DIRECTIONS, TOTAL 18 TIMES.							X		
C	OUNT DESCRIPTION OF REVISIONS		DI	DESIGNED		CHECKED	<u> </u>	ATE			
Δ											
REMARK							APPROVED	KI. AKIYAMA	10.	10. 02. 12	
		HE TEMPERATURE RISE BY CURRENT. RESISTANCE INCLUDES CONDUCTOR RESISTANCE			I IVII ESS	CHECKED	NH. SUGITA	10.	10. 02. 10		
			ST SHOULD BE DONE UNDER TEMP. 15				DESIGNED	TY. EDAGAWA	10.	10. 02. 10	
AIR PRESSURE 86 TO 106kPa, REL						DRAWN		GO. KAMIMURA	10. 02. 09		
Note QT:Qualification Test AT:Assu			rance Test X:Applicable Test D			RAWING NO. ELC4-32722		23-04	3-04		
HS		SPECIFICATION SHEET			PART NO.			DM3CS-SF			
		HIROSE ELECTRIC CO., LTD.			CODE	CODE NO.		9-0032-3-00	\triangle	1/2	

